Texas Instruments Inc. (DUNS# 00-732-1904)
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Distribute - RoHS and IEC 62474 DB
08/25/2022

#### Details for "SN74ABT377APW"

#### **Current Product Information**

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
SN74ABT377APW	NIPDAU	Level-1-260C-UNLIM	TI MALAYSIA A/T	PW   20	4.4x6.5x1.15	74.7

#### \*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

#### **Environmental Ratings Information**

RoHS	RoHS REACH Green		IEC 62474 DB
Yes	Yes	Yes	Yes

## **Component Information**

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.13249	99.997736	999977	0.177344	1773
Copper and Its Alloys	Iron	7439-89-6	0.000001	0.000755	8	0.000001	0
Precious Metals	Silver	7440-22-4	0.000002	0.00151	15	0.00003	0
Sub-Total			0.132493	100	1000000	0.177348	1773
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.504639	79.999968	800000	0.675484	6755
Thermoplastics	Ероху	85954-11-6	0.12616	20.000032	200000	0.168871	1689
Sub-Total			0.630799	100	1000000	0.844355	8444
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	27.85926	97.41	974100	37.290961	372910
Copper and Its Alloys	Iron	7439-89-6	0.6864	2.4	24000	0.918779	9188
Copper and Its Alloys	Phosphorus	7723-14-0	0.00858	0.03	300	0.011485	115
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.00858	0.03	300	0.011485	115
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.00858	0.03	300	0.011485	115
Zinc and Its Alloys	Zinc	7440-66-6	0.0286	0.1	1000	0.038282	383
Sub-Total			28.6	100	1000000	38.282477	382825
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.437552	95.12	951200	0.585684	5857
Precious Metals	Gold	7440-57-5	0.003588	0.78	7800	0.004803	48
Precious Metals	Palladium	7440-05-3	0.01886	4.1	41000	0.025245	252
Sub-Total			0.46	100	1000000	0.615732	6157
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	36.825203	86.000001	860000	49.292307	492923
Other Plastics and Rubber	Carbon Black	1333-86-4	0.12846	0.3	3000	0.17195	1719
Thermoplastics	Ероху	85954-11-6	5.86634	13.699999	137000	7.852378	78524
Sub-Total			42.820003	100	1000000	57.316635	573166
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	2.064515	100	1000000	2.763453	27635
Sub-Total			2.064515	100	1000000	2.763453	27635
Total			74.70781			100	1000000

### Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

## See Glossary of Terms for more details.

# Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

# Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

# Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

## Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

## Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 08/25/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.